







### DISCRIPTION

### **FEATURES**

Ferrite
High frequency design
Excellent Q values
Excellent SRF
High reliability
Excellent thermal stability

### **OPTIONS**

Tape & Reel is Standard (Qty: 3.000 Pcs)
Bulk Packing Available for smaller quantites
Tolerance: J = 5% and K=10% is Standard,
tighter Tolerance available (MOQ on request)

### **APPLICATIONS**

Modems
Mobile Radios
Cordless Telephones
Global Positioning Systems
Telecommunications Systems

### PHYSICAL CHARACTERISTICS

• Testing: (Equivalents acceptable) Inductance & Q-HP4191A + HP4291A

SRF: HP8553B; RDC: 25°C

• Operating Temperature : -55°C ~ 85°C

Pad metalization: Silver-nickel with 90/10 solder
Solder methods: Wave, Reflow, Vapor Phase
Solderability: Max 260°C for 10 seconds

• Marking : EIA color code

### **ELECTRICAL SPECIFICATIONS**

Properties	Test conditions		Value	Unit	Tol.
Inductance		L	22	μH	see Site 2
Q factor		Q	25		min.
DC-resistance		DCR typ.		Ω	typ.
DC-resistance		DCR max.	2,2	Ω	max.
Self-Res. Freq.		SRF	35	Mhz	min.
Test-Freq.			2,52	Mhz	
Rated Current		IDC	200	mA	max.
Saturation Current		Isat		mA	typ.

1. This electronic component is meant to be used in general electronic equipment. Before the incorporation SMT WIRE-WOUND of this component into any equipment with higher and more reliable requirements such as aviation, **CHIP INDUCTORS** aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon -Components must be informed before the stage of design-in. Evaluation checks for safety have to be Part No.: S12008-220 performed on each electronic components used in electrical circuits that require high safety and reliability functions. Customer: DRW: Chang CHKD Young MATL: Chu Chi DATE 09.06.2009 APPD: **FINISH** Vienna 1 from 2 Pong Sheet



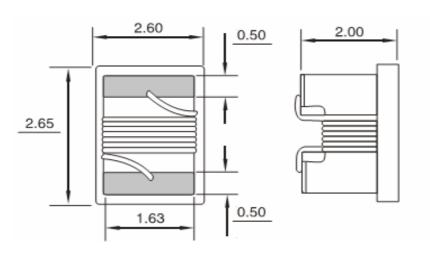


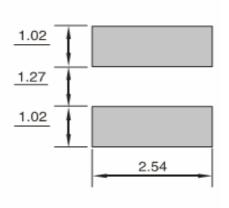




## **TECHNICAL INFORMATIONS**

### Dimensions ( mm )





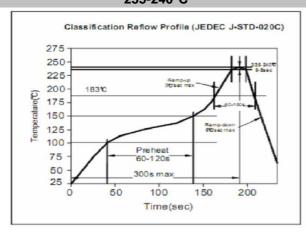
# **Ordering Information**

Serie and Range				
S12008-220				

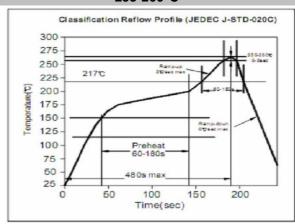
Tolerance	ROHS	Packing
K	R	TR

<b>J</b> = 5%	R = ROHS	<b>BU</b> = Bulk Ware
<b>K</b> = 10%	N = non ROHS	TR = Tape Reel
<b>M</b> = 20%		
<b>N</b> = 30%		

## **Soldering Profile for Lead Free Soldering** 235-240°C



### **Soldering Profile for Lead Free Soldering** 255-260°C



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Part No .:

functions. Customer: DRW: CHKD MATL: Chu Chi DATE 09.06.2009 Chang Young APPD: **FINISH** Pong Vienna Sheet 2 from 2

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SMT WIRE-WOUND

**CHIP INDUCTORS** 

S12008-220